

LM185-1.2/LM285-1.2/LM385-1.2 Micropower Voltage Reference Diode

General Description

The LM185-1.2/LM285-1.2/LM385-1.2 are micropower 2-terminal band-gap voltage regulator diodes. Operating over a 10 μ A to 20mA current range, they feature exceptionally low dynamic impedance and good temperature stability. On-chip trimming is used to provide tight voltage tolerance. Since the LM185-1.2 band-gap reference uses only transistors and resistors, low noise and good long term stability result.

Careful design of the LM185-1.2 has made the device exceptionally tolerant of capacitive loading, making it easy to use in almost any reference application. The wide dynamic operating range allows its use with widely varying supplies with excellent regulation.

The extremely low power drain of the LM185-1.2 makes it useful for micropower circuitry. This voltage reference can be used to make portable meters, regulators or general purpose analog circuitry with battery life approaching shelf life.

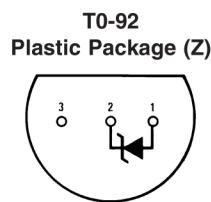
Further, the wide operating current allows it to replace older references with a tighter tolerance part.

The LM185-1.2 is rated for operation over a -55°C to 125°C temperature range while the LM285-1.2 is rated -40°C to 85°C and the LM385-1.2 0°C to 70°C. The LM185-1.2/LM285-1.2 are available in a hermetic TO-46 package and the LM285-1.2/LM385-1.2 are also available in a low-cost TO-92 molded package, as well as SO and SOT-23. The LM185-1.2 is also available in a hermetic leadless chip carrier package.

Features

- ±1% and 2% initial tolerance
- Operating current of 10 μ A to 20mA
- 1Ω dynamic impedance
- Low temperature coefficient
- Low voltage reference—1.235V
- 2.5V device and adjustable device also available
- LM185-2.5 series and LM185 series, respectively

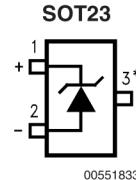
Connection Diagrams



00551810

Bottom View

Order Number LM285Z-1.2,
LM285BXZ-1.2, LM285BYZ-1.2
LM385Z-1.2, LM385BZ-1.2
LM385BXZ-1.2 or LM385BYZ-1.2
See NS Package Number Z03A

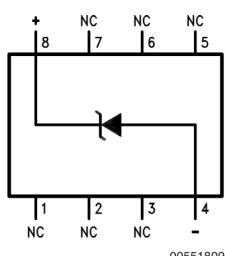


00551833

* Pin 3 is attached to the Die Attach Pad (DAP) and should be connected to Pin 2 or left floating.

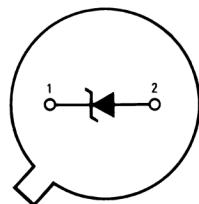
**Order Number LM385M3-1.2
See NS Package Number MF03A**

Connection Diagrams (Continued)

SO Package

00551809

Order Number LM285M-1.2,
LM285BXM-1.2, LM285BYM-1.2
LM385M-1.2, LM385BM-1.2
LM385BXM-1.2 or LM385BYM-1.2
See NS Package Number M08A

**TO-46
Metal Can Package (H)**

00551806

Bottom View
Order Number LM185H-1.2, LM185H-1.2/883,
LM185BXH-1.2, LM185BYH-1.2
LM285H-1.2 or LM285BXH-1.2
See NS Package Number H02A

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

(Note 2)

Reverse Current	30mA
Forward Current	10mA
Operating Temperature Range (Note 3)	
LM185-1.2	-55°C to +125°C
LM285-1.2	-40°C to +85°C
LM385-1.2	0°C to 70°C

Storage Temperature -55°C to +150°C

Soldering Information

TO-92 package: 10 sec. 260°C

TO-46 package: 10 sec. 300°C

SO and SOT Pkg.

Vapor phase (60 sec.) 215°C

Infrared (15 sec.) 220°C

See AN-450 "Surface Mounting Methods and Their Effect on Product Reliability" for other methods of soldering surface mount devices.

Electrical Characteristics (Note 4)

Parameter	Conditions	Typ	LM185-1.2		LM385B-1.2		LM385-1.2		Units (Limit)
			Tested Limit (Notes 5, 8)	Design Limit (Note 6)	Tested Limit (Note 5)	Design Limit (Note 6)	Tested Limit (Note 5)	Design Limit (Note 6)	
Reverse Breakdown Voltage	T _A = 25°C, 10µA ≤ I _R ≤ 20mA	1.235	1.223 1.247		1.223 1.247		1.205 1.260		V(Min) V(Max)
Minimum Operating Current		8	10	20	15	20	15	20	µA
Reverse Breakdown Voltage Change with Current	10µA ≤ I _R ≤ 1mA		1	1.5	1	1.5	1	1.5	mV (Max)
	1mA ≤ I _R ≤ 20mA		10	20	20	25	20	25	mV (Max)
Reverse Dynamic Impedance	I _R = 100µA, f = 20Hz	1							Ω
Wideband Noise (rms)	I _R = 100µA, 10Hz ≤ f ≤ 10kHz	60							µV
Long Term Stability	I _R = 100µA, T = 1000 Hr, T _A = 25°C ±0.1°C	20							ppm
Average Temperature Coefficient (Note 7)	I _R = 100µA X Suffix Y Suffix All Others		30 50 150		30 50 150			150	ppm/°C ppm/°C ppm/°C (Max)

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics. The guaranteed specifications apply only for the test conditions listed.

Note 2: Refer to RETS185H-1.2 for military specifications.

Note 3: For elevated temperature operation, T_j max is:

LM185 150°C

LM285 125°C

LM385 100°C

Thermal Resistance	TO-92	TO-46	SO-8	SOT23
θ_{JA} (junction to ambient)	180°C/W (0.4" leads) 170°C/W (0.125" leads)	440°C/W	165°C/W	283°C/W
θ_{JC} (junction to case)	N/A	80°C/W	N/A	N/A

Note 4: Parameters identified with boldface type apply at temperature extremes. All other numbers apply at $T_A = T_J = 25^\circ\text{C}$.

Note 5: Guaranteed and 100% production tested.

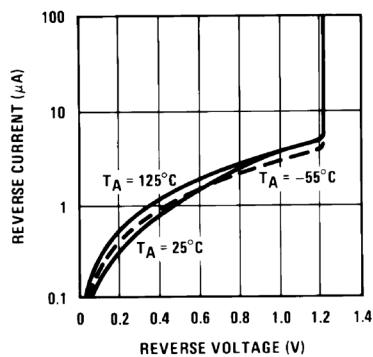
Note 6: Guaranteed, but not 100% production tested. These limits are not used to calculate average outgoing quality levels.

Note 7: The average temperature coefficient is defined as the maximum deviation of reference voltage at all measured temperatures between the operating T_{MAX} and T_{MIN} , divided by $T_{MAX} - T_{MIN}$. The measured temperatures are -55°C , -40°C , 0°C , 25°C , 70°C , 85°C , 125°C .

Note 8: A military RETS electrical specification is available on request.

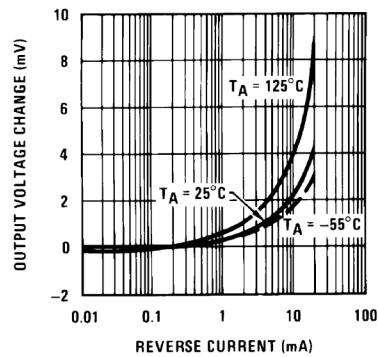
Typical Performance Characteristics

Reverse Characteristics



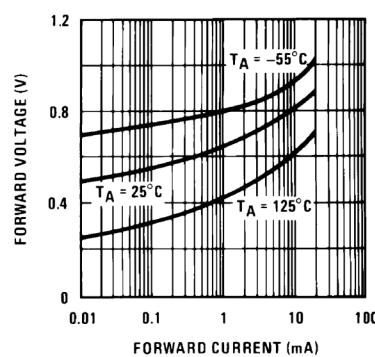
00551813

Reverse Characteristics



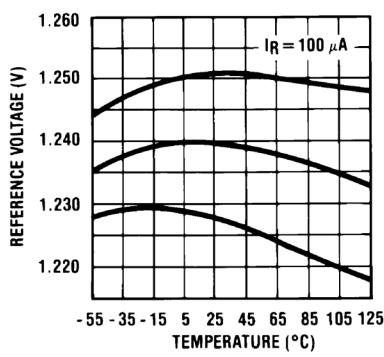
00551814

Forward Characteristics



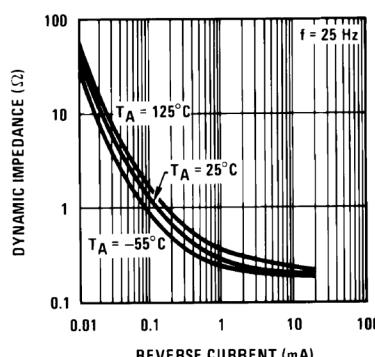
00551815

Temperature Drift of 3 Representative Units



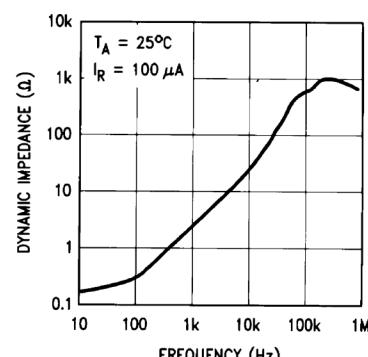
00551816

Reverse Dynamic Impedance



00551817

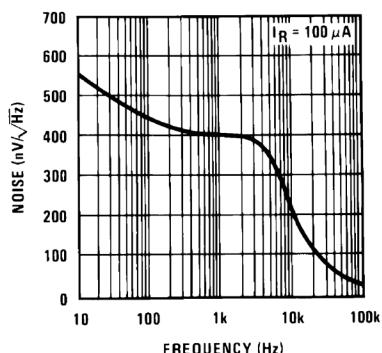
Reverse Dynamic Impedance



00551818

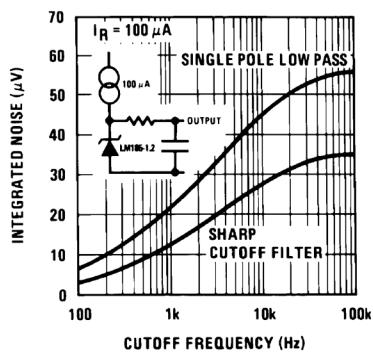
Typical Performance Characteristics (Continued)

Noise Voltage



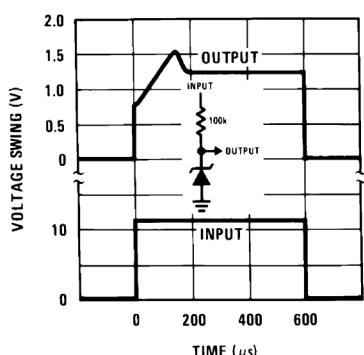
00551819

Filtered Output Noise



00551820

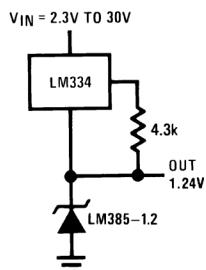
Response Time



00551821

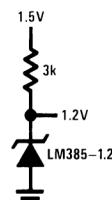
Typical Applications

Wide Input Range Reference



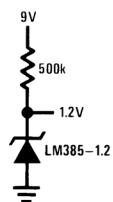
00551808

Reference from 1.5V Battery



00551823

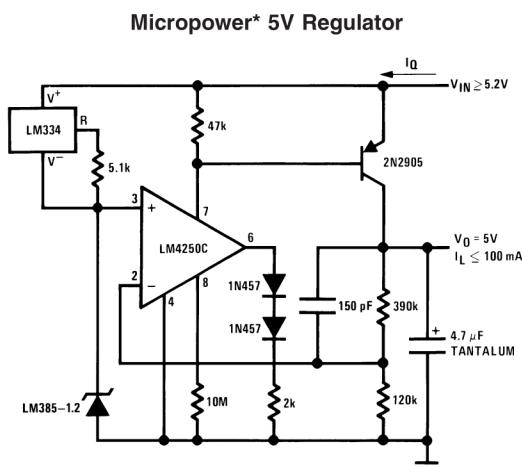
Micropower Reference from 9V Battery



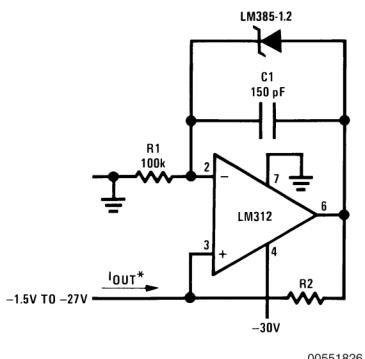
00551822

Typical Applications (Continued)

Precision 1 μ A to 1mA Current Sources

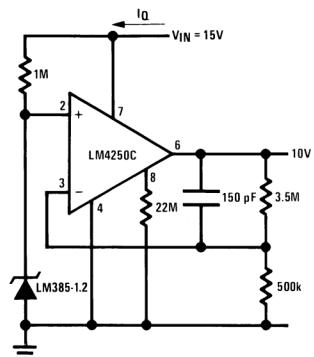


*IQ ≈ 30 μ A

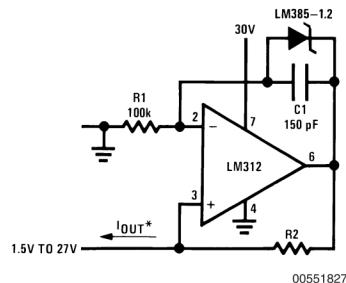


$$*I_{OUT} = \frac{1.23V}{R_2}$$

Micropower* 10V Reference



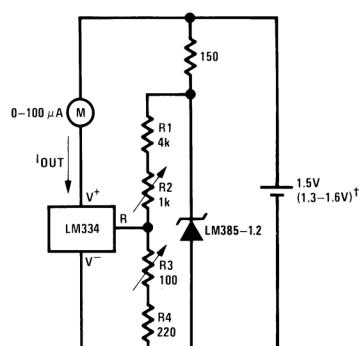
*IQ ≈ 20 μ A standby current



Typical Applications (Continued)

METER THERMOMETERS

0°C–100°C Thermometer



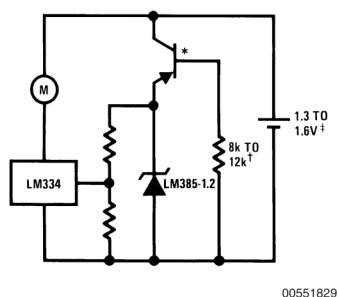
Calibration

1. Short LM385-1.2, adjust R3 for $I_{OUT} = \text{temp at } 1\mu\text{A}/\text{K}$
2. Remove short, adjust R2 for correct reading in centigrade

$\dagger I_Q \text{ at } 1.3\text{V} = 500\mu\text{A}$

$I_Q \text{ at } 1.6\text{V} = 2.4\text{mA}$

Lower Power Thermometer

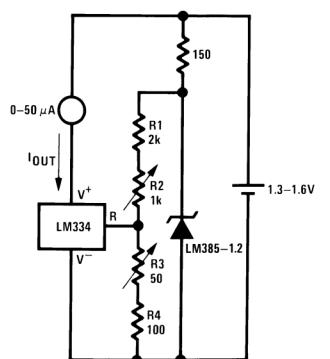


*2N3638 or 2N2907 select for inverse $H_{FE} \approx 5$

†Select for operation at 1.3V

‡ $I_Q = 600\mu\text{A}$ to $900\mu\text{A}$

0°F–50°F Thermometer

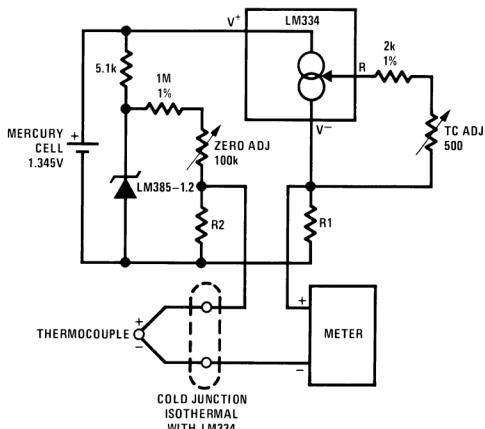


Calibration

1. Short LM385-1.2, adjust R3 for $I_{OUT} = \text{temp at } 1.8\mu\text{A}/\text{K}$
2. Remove short, adjust R2 for correct reading in °F

Typical supply current 50μA

Micropower Thermocouple Cold Junction Compensator



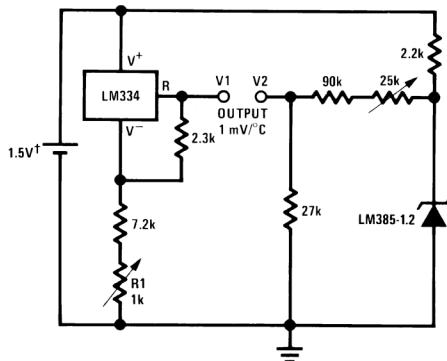
Adjustment Procedure

1. Adjust TC ADJ pot until voltage across R1 equals Kelvin temperature multiplied by the thermocouple Seebeck coefficient.
2. Adjust zero ADJ pot until voltage across R2 equals the thermocouple Seebeck coefficient multiplied by 273.2.

Thermocouple Type	Seebeck Coefficient ($\mu\text{V}/^\circ\text{C}$)	R1 (Ω)	R2 (Ω)	Voltage Across R1 @ 25°C (mV)	Voltage Across R2 (mV)
J	52.3	523.24k	15.60	14.32	
T	42.8	432.1k	12.77	11.78	
K	40.8	419.53Ω	12.17	11.17	
S	6.4	63.450Ω	1.908	1.766	

Typical Applications (Continued)

Centigrade Thermometer

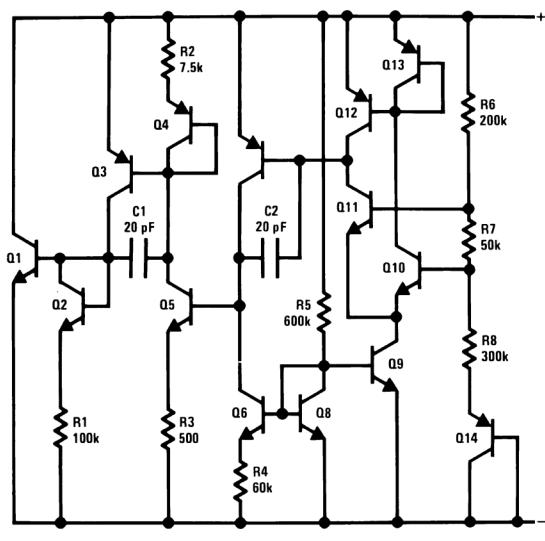


00551801

Calibration

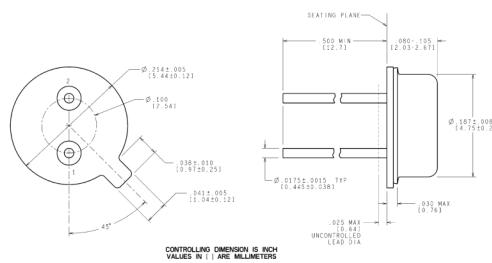
1. Adjust R1 so that V1 = temp at 1mV/K
 2. Adjust V2 to 273.2mV
- $\frac{dI_Q}{dV}$ for 1.3V to 1.6V battery voltage = 50 μ A to 150 μ A

Schematic Diagram



00551807

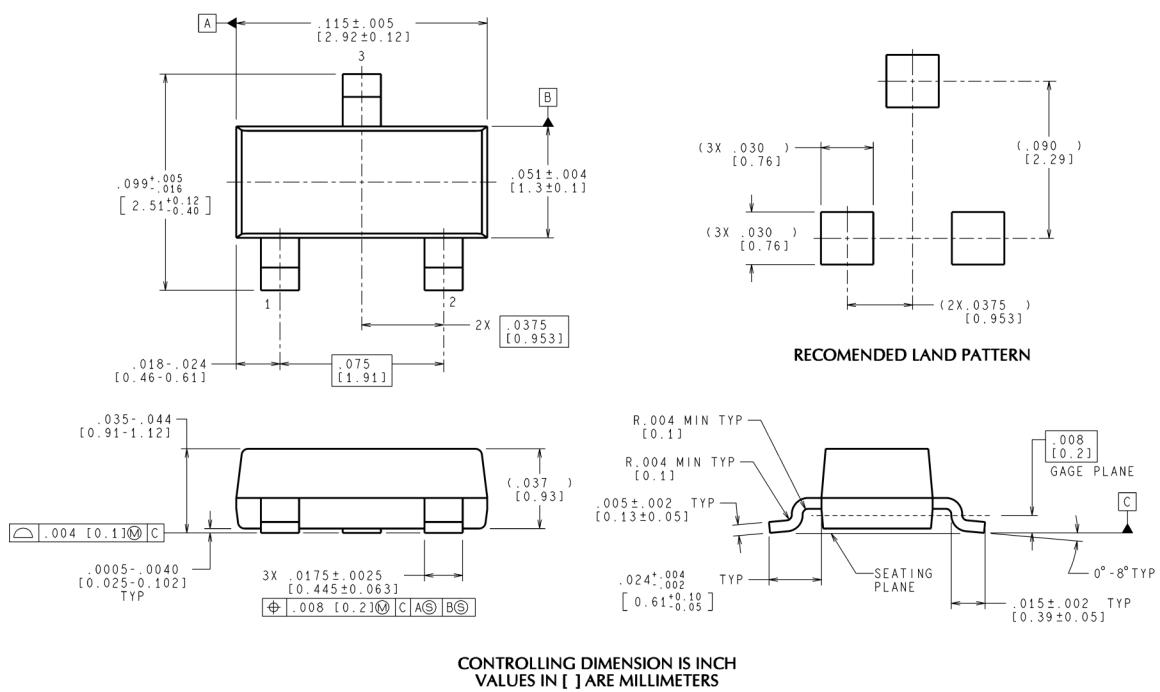
Physical Dimensions inches (millimeters) unless otherwise noted



H02A (Rev F)

TO-46 Metal Can Package (H)

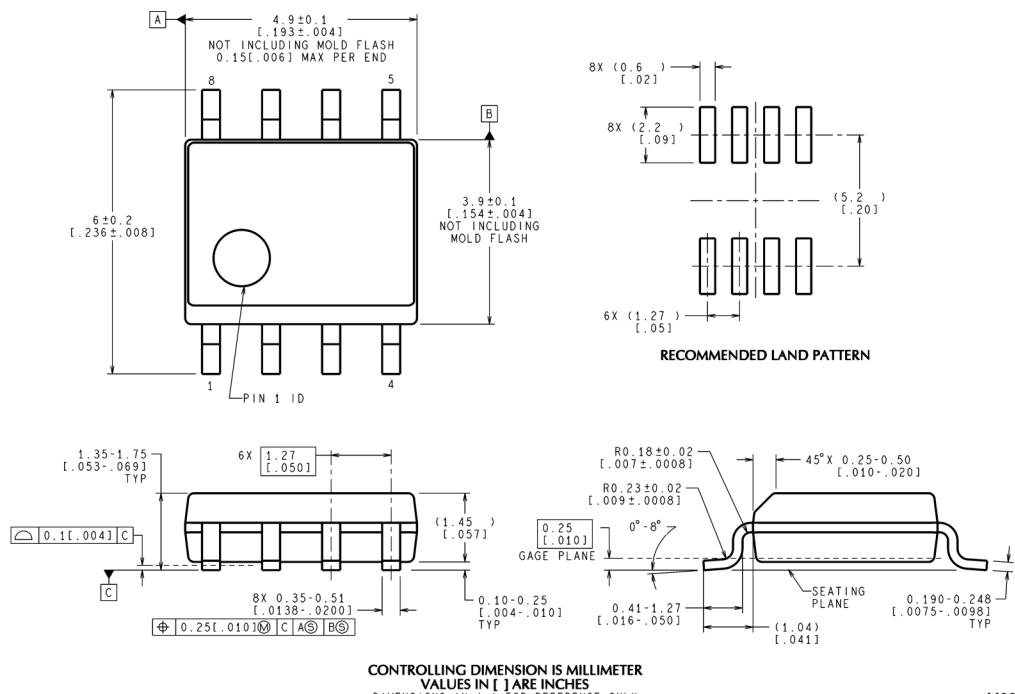
Order Number LM185H-1.2, LM185H-1.2/883, LM185BXH-1.2, LM185BYH-1.2, LM285H-1.2, or LM285BXH-1.2
NS Package Number H02A



MF03A (Rev B)

SOT-23 Package (M3)
Order Number LM385M3-1.2
NS Package Number MF03A

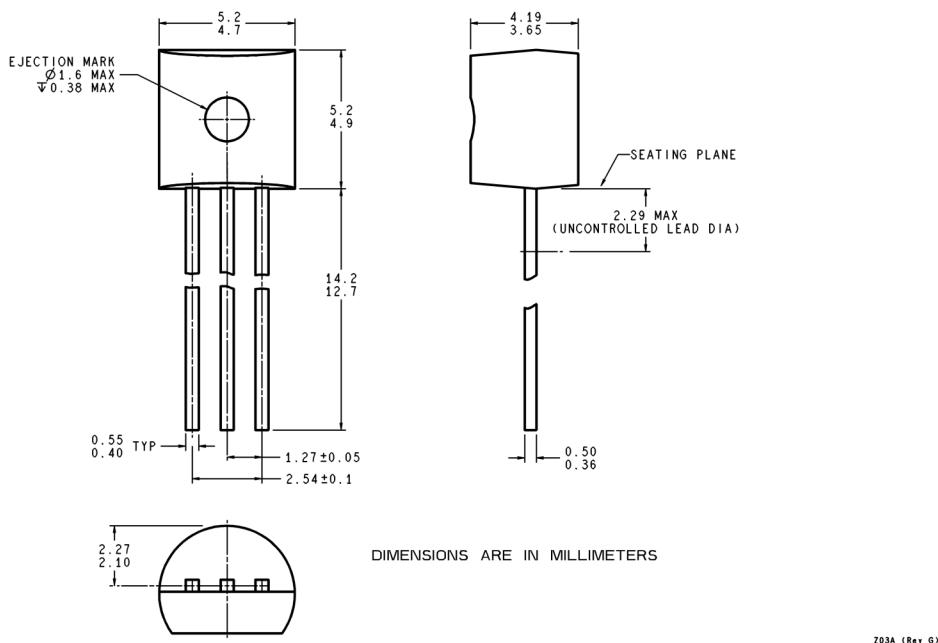
Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



M08A (Rev K)

Small Outline (SO-8) Package
Order Number LM285M-1.2, LM285BXM-1.2, LM285BYM-1.2
LM385M-1.2, LM385BM-1.2, LM385BXM-1.2, LM385BYM-1.2
NS Package Number M08A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



TO-92 Plastic Package (Z)
Order Number LM285Z-1.2, LM285BXZ-1.2
LM285BYZ-1.2, LM385Z-1.2, LM385BZ-1.2
LM385BXZ-1.2 or LM385BYZ-1.2
NS Package Number Z03A

National does not assume any responsibility for use of any circuitry described, no circuit patent licenses are implied and National reserves the right at any time without notice to change said circuitry and specifications.

For the most current product information visit us at www.national.com.

LIFE SUPPORT POLICY

NATIONAL'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT AND GENERAL COUNSEL OF NATIONAL SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

BANNED SUBSTANCE COMPLIANCE

National Semiconductor manufactures products and uses packing materials that meet the provisions of the Customer Products Stewardship Specification (CSP-9-111C2) and the Banned Substances and Materials of Interest Specification (CSP-9-111S2) and contain no "Banned Substances" as defined in CSP-9-111S2.

 **National Semiconductor**
Americas Customer Support Center
Email: new.feedback@nsc.com
Tel: 1-800-272-9959
www.national.com

National Semiconductor
Europe Customer Support Center
Fax: +49 (0) 180-530 85 86
Email: europe.support@nsc.com
Deutsch Tel: +49 (0) 69 9508 6208
English Tel: +44 (0) 870 24 0 2171
Français Tel: +33 (0) 1 41 91 8790

National Semiconductor
Asia Pacific Customer Support Center
Email: ap.support@nsc.com

National Semiconductor
Japan Customer Support Center
Fax: 81-3-5639-7507
Email: jpn.feedback@nsc.com
Tel: 81-3-5639-7560